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February 1996

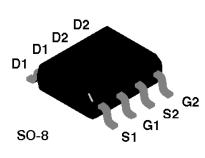
NDS9952A Dual N & P-Channel Enhancement Mode Field Effect Transistor

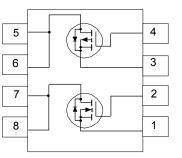
General Description

These dual N- and P-channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

Features

- N-Channel 3.7A, 30V, R_{DS(ON)}=0.08Ω @ V_{GS}=10V.
 P-Channel -2.9A, -30V, R_{DS(ON)}=0.13Ω @ V_{GS}=-10V.
- High density cell design or extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.
- Dual (N & P-Channel) MOSFET in surface mount package.





Absolute Maximum Ratings T_A= 25°C unless otherwise noted

Symbol	Parameter	N-Channel	P-Channel	Units	
V _{DSS}	Drain-Source Voltage	30	-30	V	
V _{GSS}	Gate-Source Voltage	± 20	± 20	V	
I _D	Drain Current - Continuous (Note 1a)	± 3.7	± 2.9	А	
	- Pulsed	± 15	± 10		
P _D	Power Dissipation for Dual Operation		2		
Power D	Power Dissipation for Single Operation (Note 1a)	1.6		
	(Note 1))	1		
	(Note 1c)	0.9		
T_,T _{stg}	Operating and Storage Temperature Range	-55	-55 to 150		
THERMA	L CHARACTERISTICS				
R _{øja}	Thermal Resistance, Junction-to-Ambient (Note 1	a)	78		
R _{øJC}	Thermal Resistance, Junction-to-Case (Note)	40		

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Symbol	Parameter	Conditions		Туре	Min	Тур	Max	Units
OFF CHA	RACTERISTICS	1						1
BV _{DSS}	Drain-Source Breakdown Voltage	V _{gs} = 0 V, I _p = 250 μA		N-Ch	30			V
033		$V_{gs} = 0 V, I_p = -250 \mu A$		P-Ch	-30			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\rm DS} = 24 \text{ V}, V_{\rm GS} = 0 \text{ V}$		N-Ch			2	μA
033			T _J = 55°C				25	μA
		$V_{ps} = -24 V, V_{qs} = 0 V$	-	P-Ch			-2	μA
			T _J = 55°C				-25	μA
GSSF	Gate - Body Leakage, Forward	V _{GS} = 20 V, V _{DS} = 0 V	-	All			100	nA
GSSR	Gate - Body Leakage, Reverse	$V_{gg} = -20 \text{ V}, V_{pg} = 0 \text{ V}$		All			-100	nA
	ACTERISTICS (Note 2)	1		1				1
V _{GS(th)}	Gate Threshold Voltage	V _{ps} = V _{gs} , I _p = 250 μA		N-Ch	1	1.7	2.8	V
(-)	-		T_= 125°C		0.7	1.2	2.2	
		$V_{ps} = V_{gs}, I_{p} = -250 \mu\text{A}$		P-Ch	-1	-1.6	-2.8	
			T _J = 125°C		-0.85	-1.25	-2.5	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{gs} = 10 V, I _p = 1.0 A		N-Ch		0.06	0.08	Ω
. ,			T _J = 125°C			0.08	0.13	
		V_{gg} = 4.5 V, I _D = 0.5 A				0.08	0.11	
			T _J = 125°C			0.11	0.18	
		V _{gs} = -10 V, I _p = -1.0 A		P-Ch		0.11	0.13	
			T _J = 125°C			0.15	0.21	
		$V_{gg} = -4.5 \text{ V}, \ I_{p} = -0.5 \text{ A}$				0.17	0.2	
			T _J = 125°C			0.24	0.32	
D(on)	On-State Drain Current	V_{GS} = 10 V, V_{DS} = 5 V		N-Ch	15			Α
		V_{GS} = -10 V, V_{DS} = -5 V		P-Ch	-10			
J _{FS}	Forward Transconductance	V _{DS} = 15 V, I _D = 3.7 A		N-Ch		6		S
		V _{DS} = -15 V, I _D = -2.9 A		P-Ch		4		
OYNAMIC	CHARACTERISTICS					-		
C _{iss}	Input Capacitance	N-Channel		N-Ch		320		pF
		$V_{DS} = 10 V, V_{GS} = 0 V,$ f = 1.0 MHz		P-Ch		350		
oss	Output Capacitance			N-Ch		225		pF
		P-Channel $-V_{ps} = -10 V$, $V_{cs} = 0 V$,		P-Ch		260		
C _{rss}	Reverse Transfer Capacitance	– V _{DS} = -10 V, V _{GS} = 0 V, f = 1.0 MHz		N-Ch		85		pF
				P-Ch		100		

Symbol	Parameter	Conditions	Туре	Min	Тур	Max	Units	
SWITCHI	IG CHARACTERISTICS (Note 2)							
t _{D(on)}	(on) Turn - On Delay Time	N-Channel $V_{DD} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A},$	N-Ch		10	15	ns	
			P-Ch		9	40		
ţ.	Turn - On Rise Time	V_{GEN} = 10 V, R _{GEN} = 6 Ω	N-Ch		13	20	ns	
		P-Channel	P-Ch		21	40		
D(off)	Turn - Off Delay Time	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ A},$ $V_{GEN} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	N-Ch		21	50	ns	
		$v_{\text{GEN}} = -10$ v_1 , $v_{\text{GEN}} = 0.22$	P-Ch		21	90		
t,	Tum - Off Fall Time		N-Ch		5	50	ns	
			P-Ch		8	50		
Q _g	Total Gate Charge	N-Channel $V_{DS} = 10 V,$ $I_{D} = 3.7 A, V_{GS} = 10 V$	N-Ch		9.5	27	nC	
			P-Ch		10	25		
Q _{gs}	Gate-Source Charge	$h_{\rm D} = 0.7 \text{A}, v_{\rm GS} = 10 \text{V}$	N-Ch		1.5		nC	
		P-Channel $V_{DS} = -10 V,$ $I_{D} = -2.9 A, V_{GS} = -10 V$	P-Ch		1.6			
Q _{qd}	Gate-Drain Charge		N-Ch		3.3		nC	
			P-Ch		3.4			
DRAIN-SC	OURCE DIODE CHARACTERISTIC	CS AND MAXIMUM RATINGS						
I _s	Maximum Continuous Drain-Source Diode Forward Current		N-Ch			1.2	Α	
			P-Ch			-1.2		
V _{SD}	Drain-Source Diode Forward Voltage	$V_{gs} = 0 V, I_s = 1.25 A (Note 2)$	N-Ch		0.8	1.3	V	
		$V_{gs} = 0 V, I_s = -1.25 A$ (Note 2)	P-Ch		-0.8	-1.3		
t,	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, \text{ I}_{\text{F}} = 1.25 \text{ A}, \text{ dI}_{\text{F}}/\text{dt} = 100 \text{ A}/\mu\text{s}$	N-Ch			75	ns	
		$V_{GS} = 0 V$, $I_{F} = -1.25 A$, $dI_{F}/dt = 100 A/\mu s$	P-Ch			100	7	

1. R_{g,k} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{g,k} is guaranteed by design while R_{g,k} is determined by the user's board design.

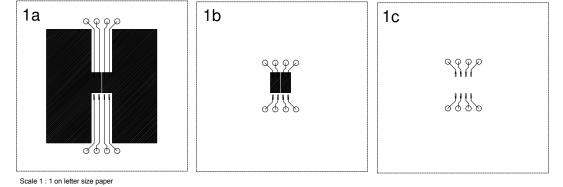
 $P_D(t) = \frac{T_J - T_A}{R_{\theta J} \, \underline{\lambda}^t} = \frac{T_J - T_A}{R_{\theta J} \, \underline{c}^t R_{\theta C} \underline{A}^{t}} = I_D^2(t) \times R_{DS(CN)} \, \underline{\theta}_{T_J}$

Typical R_{BA} for single device operation using the board layouts shown below on 4.5"x5" FR-4 PCB in a still air environment:

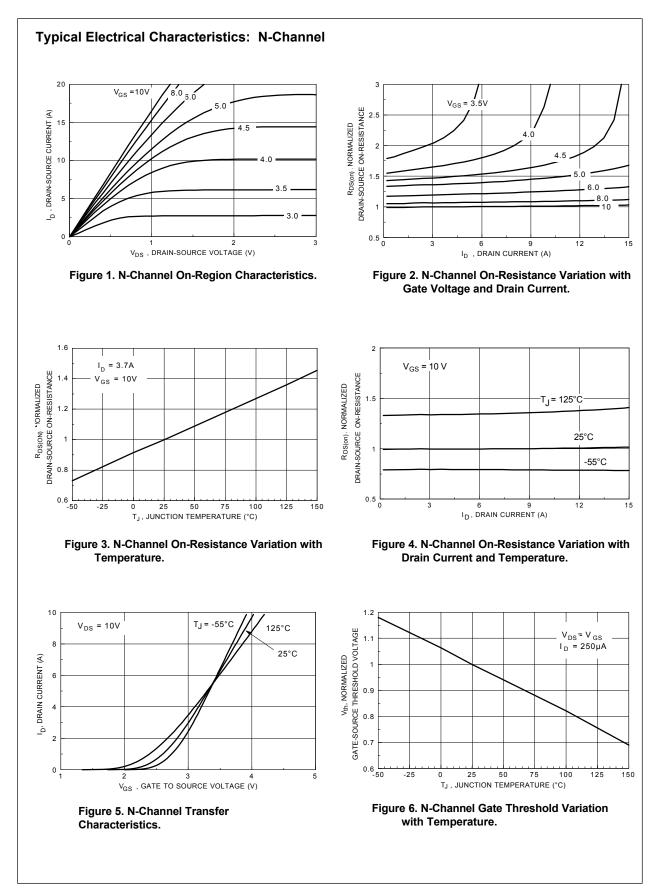
a. 78°C/W when mounted on a 0.5 in² pad of 2oz cpper.

b. 125°C/W when mounted on a 0.02 in² pad of 2oz cpper.

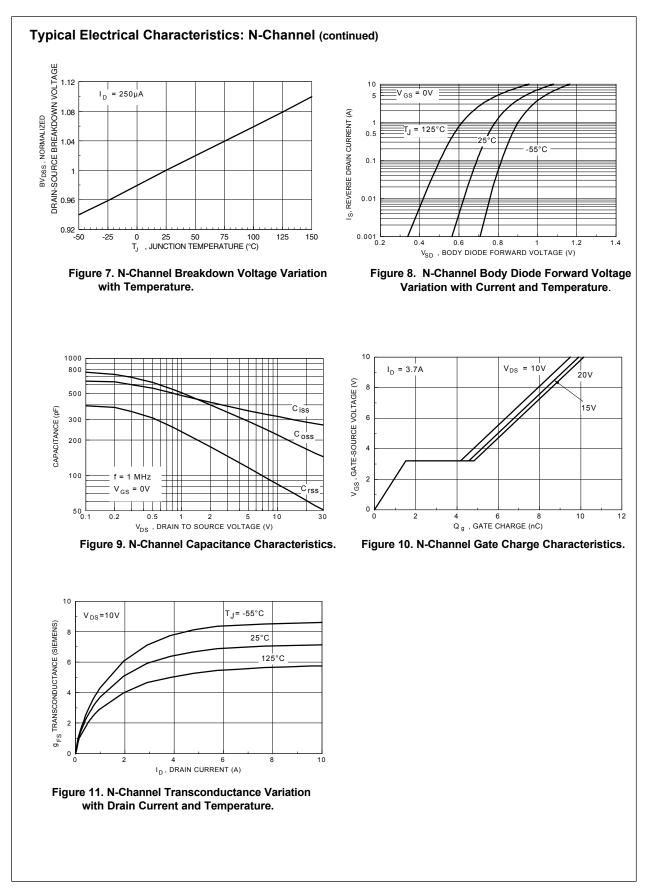
c. 135°C/W when mounted on a 0.003 \mbox{in}^2 pad of 2oz cpper.



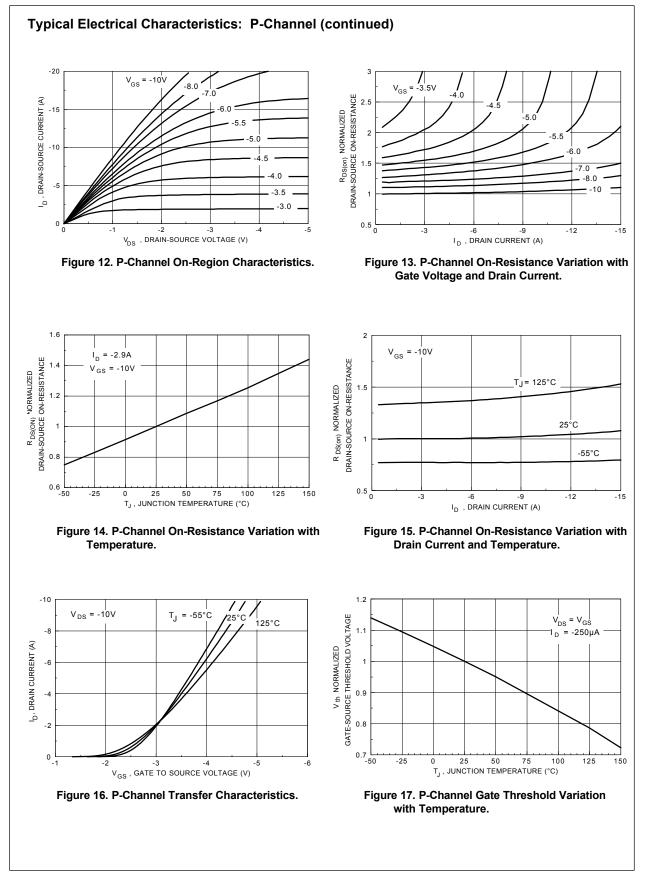
2. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.

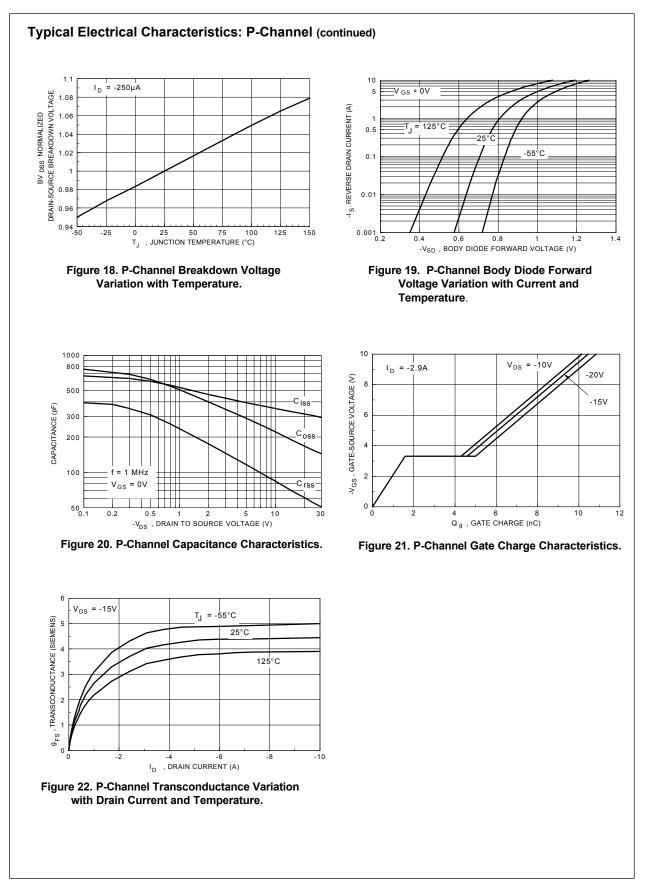


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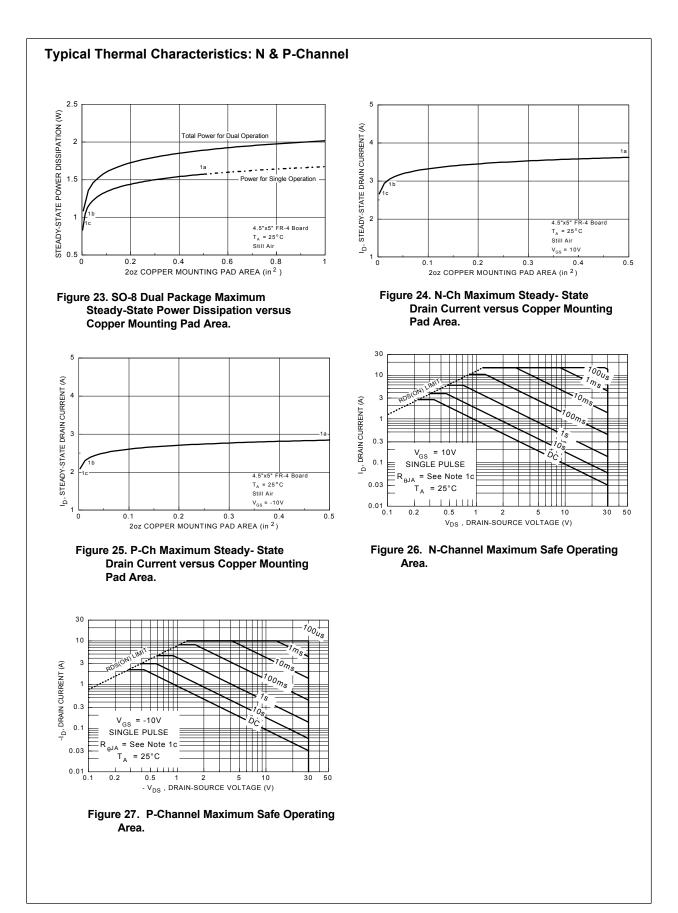


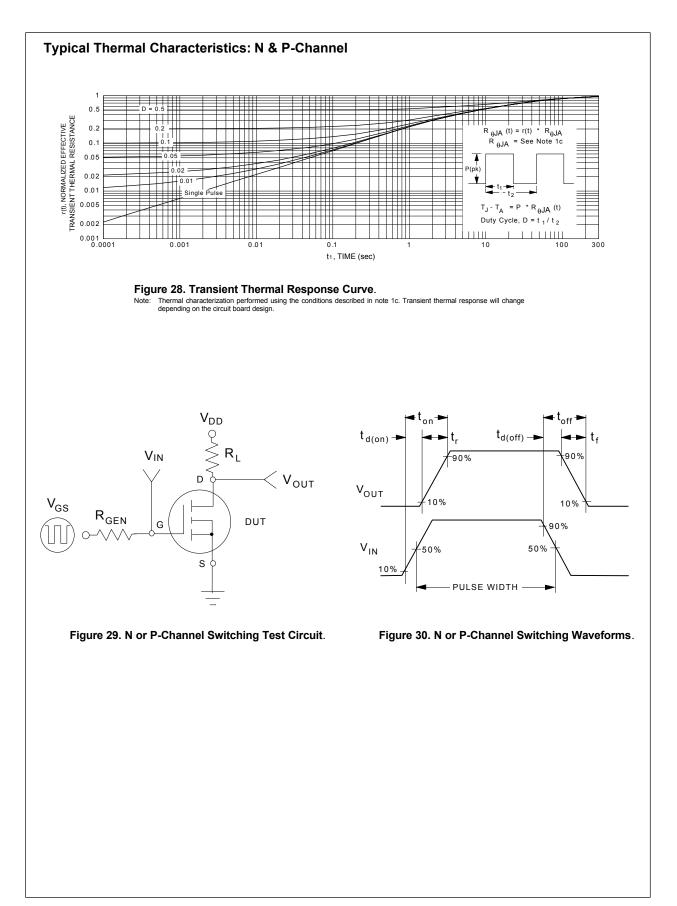
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NDS9952A.SAM





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